

REFOND:WI-E-045 A/4 REV:E/4

话: **5.9**55-2967-5000 传真: 0755-6683-9322

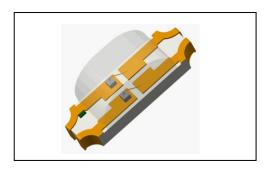
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## 1. Description 产品介绍

### 1.1 General Description 产品描述



The Colour LED which was fabricated using a yellow-green chip and a yellow chip, Package

Dimension: 3.2mmX1.0mmX1.48mm.

这产品为双鱼光 LED,由黄绿光和黄光晶片封装形成,产品尺寸: 3.2mmX1.0mmX1.48mm。

### 1.2 Features 产品特征

Extremely wide viewing angle 发光角度大

Suitable for all SMT assembly and solder process.适用于所有的SMT组装和焊接工艺。

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Moisture sensitivity level: Level 3.防潮等级 Level3

RoHS compliant.满足RoHS要求

## 1.3 Application 产品应用

Optical indicator.类常指字子

Switch and symbol, display.开关和标志,显示器等

General use.其他应用



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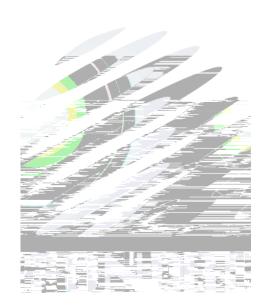
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地址。它本出资训支票和区部是投票产业中产品









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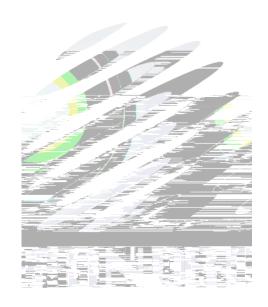
地址。它在省级训事类组区融行及瑞典业集大厦工



## 1.5 Product Parameters 产品参数

Table 1-1 Electrical / Optical Characteristics at Ts=25°C 电性与光学特性

Item 项目	Test Condition 测试条件	Syn 符		Code 代码	Min. (最小值)	Value Typ. (典型值)	Max. (最大值)	Unit 单位	
Spectral Half Bandwidth	I- 20m A			,	-	15		nm	
半波宽	IF=ZUITIA	20111A	IOMA		'		15		nm
Forward Voltage	I_ 20m A	l==20mA VF		1L	1.8		2.4	\/	
正向电压	I <sub>F=20mA</sub>		•	1L	1.8	•	•	V	



Notes 备注: VR=5V For test conditions. VR=5V 上测试公许各位

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### Table 1-2 Absolute Maximum Ratings at Ts=25°C 绝对最大值

Parameter(参数)	Symbol(符号)	Rating(值)	Units(单位)
Parameter (多数)	Symbol (村亏)		Units (单位)

### Notes 备注:

- 1. 1/10 Duty cycle, 0.1ms pulse width. 脉宽0.1ms,占空比1/10.
- 2. The above forward voltage measurement allowance tolerance is ±0.1V. 以上所示电压测量误差±0.1V.
- 3. The above dominant wavelength measurement allowance tolerance is 2nm. 以主波长测量误差±2nm.
- 4. The above luminous intensity measurement allowance tolerance ±10%. 上述发光强度的测试允许公差±10%.
- 5. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product. 使用功率不能超过规定的最大值。
- 6. All measurements were made under the standardized environment of Refond. |所有测试都是基于瑞丰现有的:标准测试平台。
- 7.When the LEDs are in operation the maximum current should be decided after measuring the package temperature, junction temperature should not exceed the maximum rate. LED 使用的最大电流需要根据散热条件确定,结温不能超过最大值。

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## 1.6 Typical Optical Characteristics Curves 如道 (1.4) 1.6 Typical Optical Characteristics Curves (1.6) 1.6 Typical Optical Characteristics (1.6) 1.6 Typical Characteri

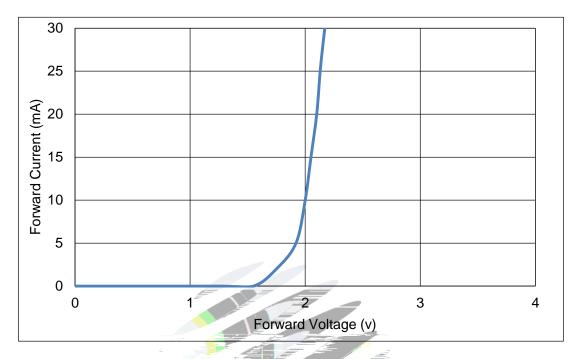
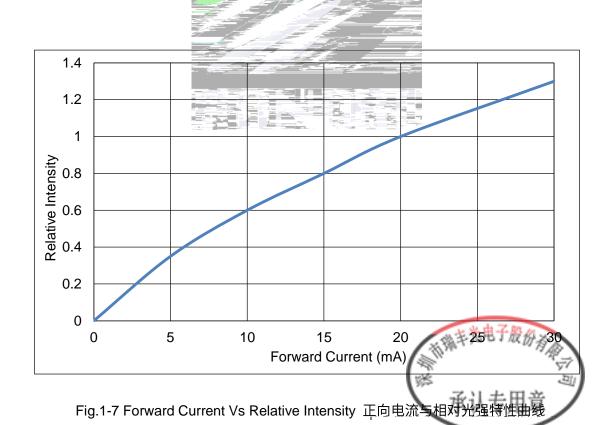


Fig.1-6 Forward Voltage Vs Forward Current 伏安特性曲线



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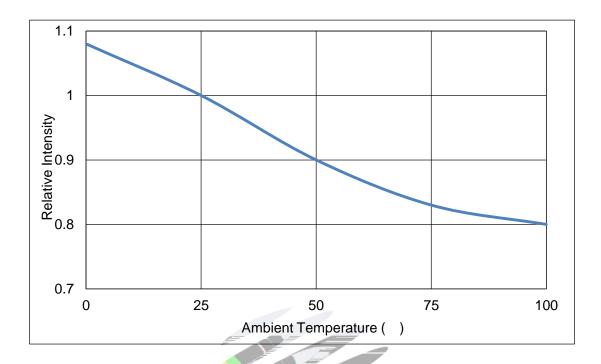


Fig.1-8 Pin Temperature Vs Relative Intensity 引脚温度与相对光强特性曲线

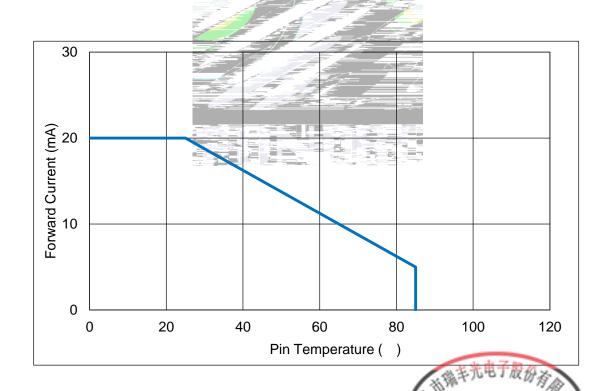


Fig.1-9 Pin Temperature Vs Forward Current 引脚温度与正向电流特性曲线

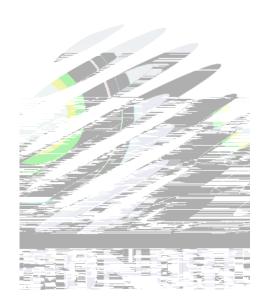
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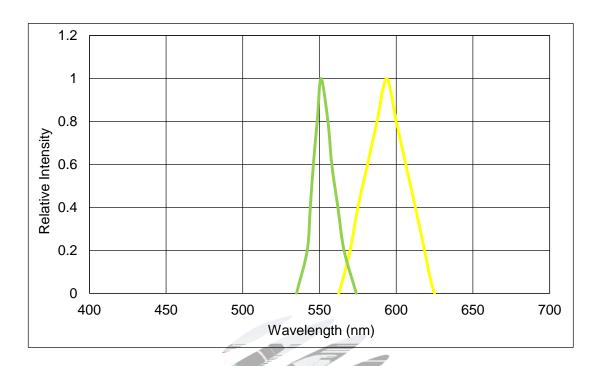
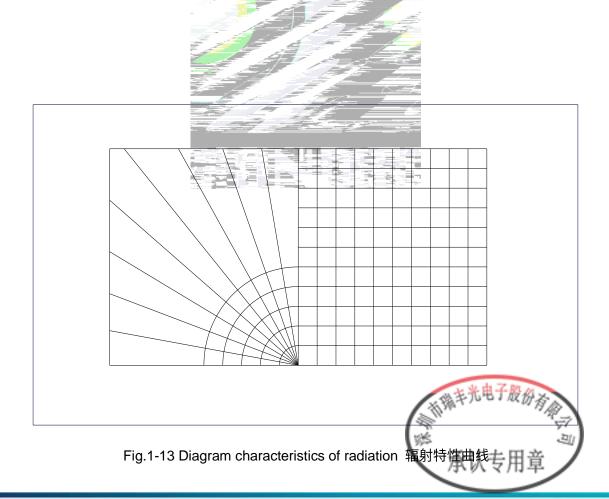


Fig.1-12 Relative Intensity Vs Wavelength (Ta=25 ) 担对光强与波长关系典线。



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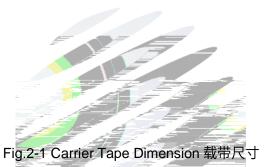


# 2. Packaging 产品包装

# 2.1 Packaging Specification 包装规格

Package:3000pcs/reel.包装每卷 3000pcs。

### 2.1.1 Carrier Tape Dimension 载带尺寸



### 2.1.2 Reel Dimension 卷盘尺寸



Table 2-1 Dimension 尺寸

Fig.2-2 Reel Dimension 卷盘尺寸

Notes 备注:

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### 2.1.3 Label Form Specification 标签规格

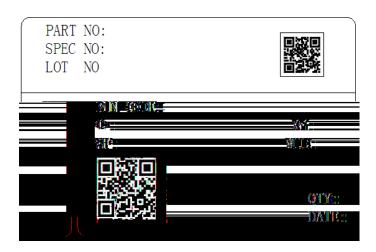


Fig. 2-3 Label Form Specification 标签规格

Table 2-2 Parameter 参数

PART NO.	Part Number 品名
SPEC NO.	Spec Number 规格
LOT NO.	Lot Number 批次号
BIN CODE	Bin Code 参数代码
	Luminous flux 光通量
XY	Chromaticity Bin 色区
VF	Forward Voltage 正向电压
WLD	Wavelength 波长代码
QTY	Packing Quantity 数量
DATE	Made Date 生产日期

# 2.2 Moisture Resistant Packing 防潮包装



Fig.2-4 Moisture Resistant Packing 防潮包装

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## 2.3 Cardboard Box 包装纸箱

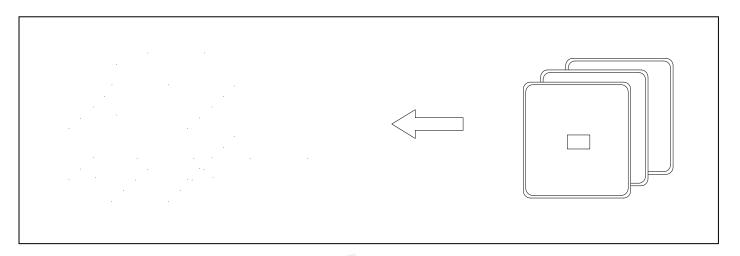


Fig.2-5 Cardboard Box 包装纸箱

# 2.4 Reliability Test Items And Conditions 信赖性测试项目及条件

Table 2-3 Reliability Test Items And Conditions 信赖性测试项目及条件

Test Items 项目	Ref.Standard 参考标准	Test Condition 测试条件	Time 时间	Quantity 数量	Ac/Re 接收/拒收
Reflow 回流焊	JESD22-B106	T <sub>emp</sub> :260°Cmax T=10 sec	2 times	22Pcs.	0/1
Temperature Cycle 温度循环	JESD22-A104	100°C 30 min 5 min -40°C 30 min	100 cycles	22Pcs.	0/1
Thermal Shock 冷热冲击	JESD22-A106	-40°C 15min 100°C 15min	300 cycles	22Pcs.	0/1
High Temperature Storage 高温保存	JESD22-A103	T <sub>emp</sub> :100°C	1000 hrs.	22Pcs.	0/1
Low Temperature Storage 低温保存	JESD22-A119	T <sub>emp</sub> :-40°C	1000 hrs.	1 22Pcs	0/1
Life Test 常温通电	JESD22-A108	T <sub>a</sub> =25°C I <sub>F</sub> =20mA	000 hrs.	大学用CO	0/1

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## 2.5 Criteria For Judging Damage 失效判定标准

Table 2-4 Criteria For Judging Damage 失效判定标准

Test Items 项目	Symbol 符号	Test Condition 测试条件	Criteria For Judgement 判定标准		
7,0	L 6.1	13/3 20/2//	Min. 最小	Max. 最大	
Forward Voltage 正向电压	VF	I=20mA	-	U.S.L*)x1.1	
Reverse Current 漏电流	lR	V <sub>R</sub> = 5V	-	U.S.L*)x2.0	
Luminous Flux 光通量		I <sub>F</sub> =20mA	L.S.L*)x0.7	-	

### Notes 备注:

1.U.S.L: Upper standard level 规格上限 L.S.L: I

L.S.L: Lower standard level 规格下限

- 2.The above reliability tests is based on the verification of a single/strip LED of Refond's existing experimental platform, the reliability experiment was taken under good heat dissipation conditions. When customers applies the LED to the series and parallel circuit, should take consideration of all the factors such as the current, voltage distribution, heat dissipation and others. 以上可靠性测试是基于瑞丰现有实验平台单颗/条 LED 在良好散热条件验证下的结果。客户端将 LED 应用于串、并联线路时,需自行评估电流、电压分配、散热等问题。
- 3.The technical information shown in the data sheets is limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license. 以上技术数据仅为产品的典型值,只作为参考,不作为任何应用条件及应用方式的保证。

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# 3. SMT Reflow Soldering Instructions SMT

# 3.1 SMT Reflow Soldering Instructions SMT 回流焊说明

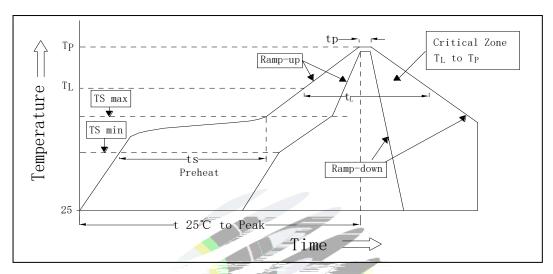


Fig.3-1 SMT Reflow Soldering Instructions SMT 回流焊说明

Table 3-1 Parameters 参数

Average temperature rise speed平均升温速度(Tsmax 至Tp)	最高3 ℃/秒 Max 3 ℃/ s
Preheating: minimum temperature预热: 最低温度 (Tsmin)	150 °C
Preheating: Max temperature预热: 最高温度 (Tsmax)	200 °C
Preheating: Time预热:时间(Tsmin 至Tsmax)	60 - 120秒 60s-120s
Time limited to maintain high temperature: the temperature限时维持高温: 温度 (T∟)	217 °C
Time limited to maintain high temperature: The Time 限时维持高温: 时间 (t∟)	60秒-150秒 60s-150s
Peak /Classification of temperature:峰值 / 分类温度 (T₂)	260 °C
Time limit classification of peak temperature time限时峰值分类温度:时间(tp)	最多10秒 Max 10s
与实际峰值温度 (T₂) 相差 5 °C 以内的保持时间 Hold time within 5 °C with the	最多30秒 Max 30s
actual peak temperature (TP)	di Zita
actual peak temperature (TP) 降温速度 Cooling speed	<u> </u>

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### Notes 备注:

- (1) Reflow soldering should not be done more than twice. If more than 24 hours between the two solderings, LED will be damaged. 回流焊次数不可以超过两次,两次回流焊的时间间隔如果超过24小时,LED可能由于吸湿 而损坏。
- (2)Whensoldering, do not put stress on the LEDs during heating. 岩焊接过,不要在材料局边对用力压胶体表面。
- 3.1.1 Soldering Iron 烙铁焊接
- (1) When do soldering by hand, keep the temperature of iron below less 300 less than 3 seconds 当手工焊接时,烙铁的温度必须小于300℃,时间不可超过3秒。
- (2) Soldering by hand should be done only one time.手工焊接只可焊接一次。
- 3.1.2 Repairing 修补

Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed in advance whether the characteristics of LEDs will or not be damaged by repairing.

会损坏LED本身的特性。 3.1.3 Cautions 注意事项

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be impacted on the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when usethe picking up nozzle, the pressure on the silicone resin should be proper. LED封装胶为硅胶, 表面较软,用力按压胶体表面会影响LED可靠性,因此应有预防措施避免在按压器件,当使用吸嘴时, 胶体表面的压力应是恰当的。

- (2) Components should not be mounted on warped (non coplanar) portion of PCB. After soldering, do not warp the circuit board LED 灯珠不要焊接在弯曲的 PCB 板上。焊接之后,也不要弯纸线路, 板。
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering. Do not rapidly cool device after soldering.回流焊之后冷却过程中,不 要对材料实加外力,也不要有震动,回流焊后,不要采用激剧冷却的方式。

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## 4. Handling Precautions 产品使用注意事项

## 4.1 Handling Precautions 产品使用注意事项

- (1) LED operating environment and sulfur element composition cannot be over 100PPM in the LEDmating usage material. This is provided for informational purposes only and is not a warranty or endorsement.LED 工作环境及与 LED 适配的材料中硫元素及化合物成份不可超过 100PPM.这只是一个建议,不作任何品质担保。
- (2) In order to prevent ex-ternal material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM, the single content of Chlorine elementis required to be less than 900PPM, the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement.为了防止外界物质进入 LED 内部以造成 LED 的损伤,所处环境及所用套件等等,单一的溴元素含量要求小于 900PPM 工厂 100PPM 混合物 900PPM 混合物 900PPM 混合物 900PPM 100PPM 100
- (3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against theuse of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verifycompatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended tobe used. Attaching LEDs, do not use adhesives that outgas organic vapor.

子及热的条件下,会导致 LED 变色,进而造成严重光衰,提前了解套件材料能够避免产生这些问题。 瑞丰反对使用任何对 LED 器件的性能或者可靠性有害的物质或材料。不管这些材料是可经过常多的。 还是仅仅怀疑有害。针对特定的用途和使用环境,瑞丰建议对所有的物质和材料进行相容性的测试。 在贴装 LED 时候,不要使用能产生有机据发性气体的粘结剂。

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(4) Handle the component along the side surface by using forceps or appropriate tools; Do not directlytouch or Handle the silicone lens surface, it may damage the internal circuitry.通过使用适当的工具从材料侧面夹取,不可直接用手或尖锐金属压胶体表面,它可能会损坏内部电路。

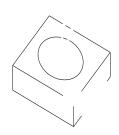




Fig 4-1 Handling Precautions

- (6) Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color change and so on. Please consider the heat generation of the LEDs when making the system design. LED 穷旱因为自身的发热和环境。的温度改变而改变,温度升高会降低 LED 发光效率,影响发光颜色,所以在设计时应充分考虑散热问题。
- (7) Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust, requiring special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components. Refond suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or

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resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED. 与其他封装胶相比,硅胶通常较软,表面易吸附脏物,应用时应特别注意,当对产品洁净度 <u> 要此就事的自己在某些意思。不是一种比较高端需求是那些地态。因此是他该能够自然是要不是一种的</u> 标准流剂。这类似的所含到被序数数据,超过通常流淌能会对ED 描述揭露因之故意以创造数字式表示

Conditions Temperature **Humidity** Time 种类 时间 温度 湿度 Within 1 Year From Date Before Opening Aluminum Bag ≤30°C ≤75% 拆包前 一年内 Storage 储存 After Opening Aluminum Bag 168hours ≤30°C ≤60% 拆包后 168小时 Baking ≥24hours 60±5°C 烘烤 大于24小时

Table 4-1Storage 储存

(8) If the moisture absorbent material silica gel has faded away or the LEDs have exceeded the storage time, baking treatment should be performed after unpacking and based on the following condition 60 5 for above 24 hours.如果干燥剂或包装失效,或者产品不符合以上 有效储存条件。需抵包后进行性绪。性烤条件: 60±5℃,大于24小时。

If the package is flatulence or damaged, please notify the sales staff to assist.如果包装账气或者

(9) Similar to most Solid state devices; LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). 像其他的半导体电子器件一样,LED 对静电过流击穿非常敏感,需 要做好防护。

(10) Other points for attention, please refer to our relevant information.其它注意事项请参照瑞丰相 头资料。.....

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## Version History/修订历史

Date日期	Revisor修订者	Version版本	Verifier审核	Remarks备注
2018.04.17	王华建	E/1	宋明	新版本制定
2021.06.17	贾彬浩	E/2	宋明	更新规格书模板
2022.05.18	贾彬浩	E/3	刘军	更正烧烤温度
2023.12.12	曾晓芬	E/4	刘军	更正焊盘图及规格书模板同步更新
			承认专员	160 有意子

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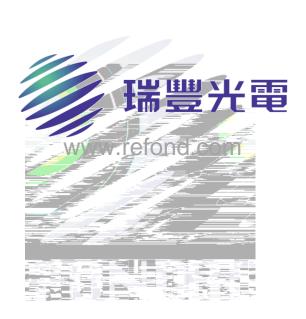
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### Declare 申明

This specification is written both in English and in Chinese and the latter is 产品规格书以中英文方式书写,若有冲突以中文版本为准。

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